

LAY T67B

Multi TOPLED®



Applications

- Electronic Equipment

Features:

- Package: white PLCC-4 package, colorless clear resin
- Chip technology: InGaAlP
- Typ. Radiation: 120° (Lambertian emitter)
- Color: $\lambda_{\text{dom}} = 617 \text{ nm}$ (● amber); $\lambda_{\text{dom}} = 587 \text{ nm}$ (● yellow)
- Optical efficacy: 16 lm/W; 24 lm/W
- Corrosion Robustness Class: 3B
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)

Ordering Information

Type	Brightness ¹⁾	Ordering Code
LAY T67B-T2V1-1-1+U2V2-45		Q65110A2433
● amber	● $I_v = 355 \dots 900 \text{ mcd}$ ($I_F = 50 \text{ mA}$)	
● yellow	● $I_v = 560 \dots 1120 \text{ mcd}$ ($I_F = 50 \text{ mA}$)	

Maximum Ratings

Parameter	Symbol		Values	Values
			● amber	● yellow
Operating Temperature	T_{op}	min.	-40 °C	-40 °C
		max.	100 °C	100 °C
Storage Temperature	T_{stg}	min.	-40 °C	-40 °C
		max.	100 °C	100 °C
Junction Temperature	T_j	max.	125 °C	125 °C
Forward Current $T_A = 25\text{ °C}$	I_F	max.	50 mA	50 mA
Surge Current $t \leq 10\text{ }\mu\text{s}$; $D = 0.005$; $T_A = 25\text{ °C}$	I_{FS}	max.	100 mA	100 mA
Reverse voltage ²⁾ $T_A = 25\text{ °C}$	V_R	max.	12 V	12 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}		2 kV	2 kV

Characteristics

$I_F = 50 \text{ mA}$; $T_A = 25 \text{ °C}$

Parameter	Symbol		Values	Values
			● amber	● yellow
Dominant Wavelength ³⁾	λ_{dom}	min.	612 nm	586 nm
		typ.	617 nm	587 nm
		max.	624 nm	592 nm
Viewing angle at 50% I_V	2ϕ	typ.	120 °	120 °
Forward Voltage ⁴⁾ $I_F = 50 \text{ mA}$	V_F	min.	1.90 V	1.90 V
		typ.	2.10 V	2.20 V
		max.	2.50 V	2.50 V
Reverse current ²⁾ $V_R = 12 \text{ V}$	I_R	max.	10 μA	10 μA
Temperature Coefficient of Peak Wavelength	$TC_{\lambda_{\text{peak}}}$	typ.	0.15 nm / K	0.13 nm / K
Temperature Coefficient of Dominant Wavelength	$TC_{\lambda_{\text{dom}}}$	typ.	0.08 nm / K	0.1 nm / K
Temperature Coefficient of Forward Voltage	TC_{V_F}	typ.	-1.7 mV / K	-3.7 mV / K
Real thermal resistance junction/solderpoint ⁵⁾	$R_{\text{thJS real}}$	max.	260 K / W	260 K / W

Brightness Groups

- amber

Group	Luminous Intensity ¹⁾		
	$I_F = 50 \text{ mA}$ min. I_v	$I_F = 50 \text{ mA}$ max. I_v	
T2	355 mcd	450 mcd	1210 mlm
U1	450 mcd	560 mcd	1520 mlm
U2	560 mcd	710 mcd	1910 mlm
V1	710 mcd	900 mcd	2420 mlm

Brightness Groups

- yellow

Group	Luminous Intensity ³⁾		
	$I_F = 50 \text{ mA}$ min. I_v	$I_F = 50 \text{ mA}$ max. I_v	
U2	560 mcd	710 mcd	1910 mlm
V1	710 mcd	900 mcd	2420 mlm
V2	900 mcd	1120 mcd	3030 mlm

Forward Voltage Groups

- amber

Group	Forward Voltage ⁴⁾ $I_F = 50 \text{ mA}$ min. V_F	Forward Voltage ⁴⁾ $I_F = 50 \text{ mA}$ max. V_F
3	1.90 V	2.20 V
4	2.20 V	2.50 V

Forward Voltage Groups

- yellow

Group	Forward Voltage ⁴⁾ $I_F = 50 \text{ mA}$ min. V_F	Forward Voltage ⁴⁾ $I_F = 50 \text{ mA}$ max. V_F
3A	1.90 V	2.05 V
3B	2.05 V	2.20 V
4A	2.20 V	2.35 V
4B	2.35 V	2.50 V

Wavelength Groups

- amber

Group	Dominant Wavelength ³⁾ min. λ_{dom}	Dominant Wavelength ³⁾ max. λ_{dom}
1	612 nm	624 nm

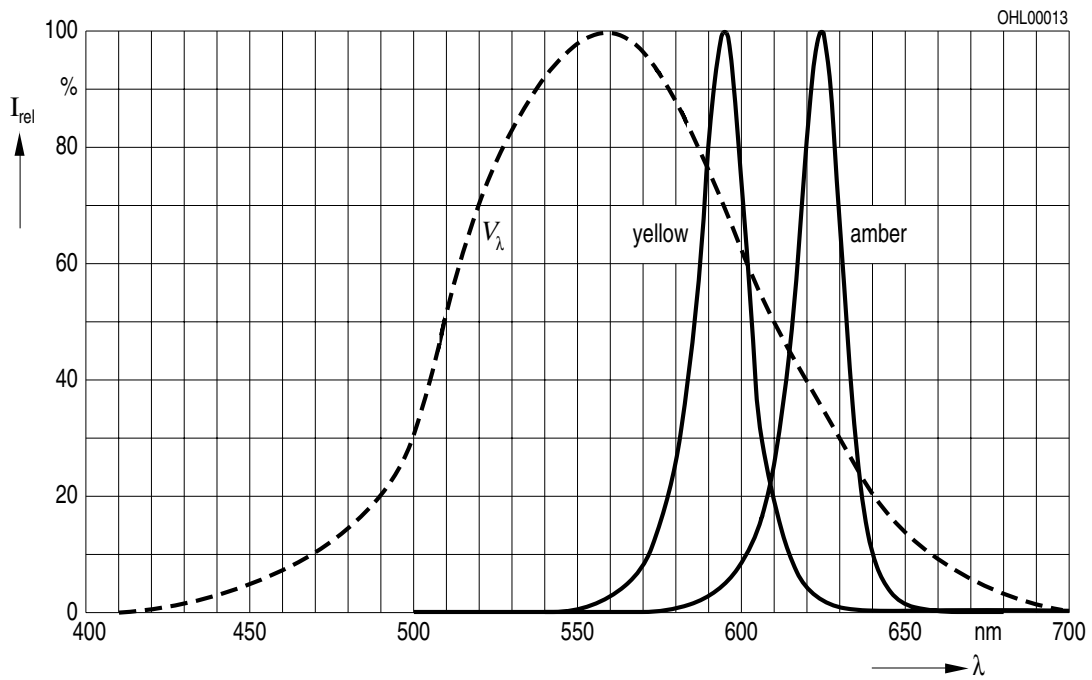
Wavelength Groups

- yellow

Group	Dominant Wavelength ³⁾ min. λ_{dom}	Dominant Wavelength ³⁾ max. λ_{dom}
4	586 nm	589 nm
5	589 nm	592 nm

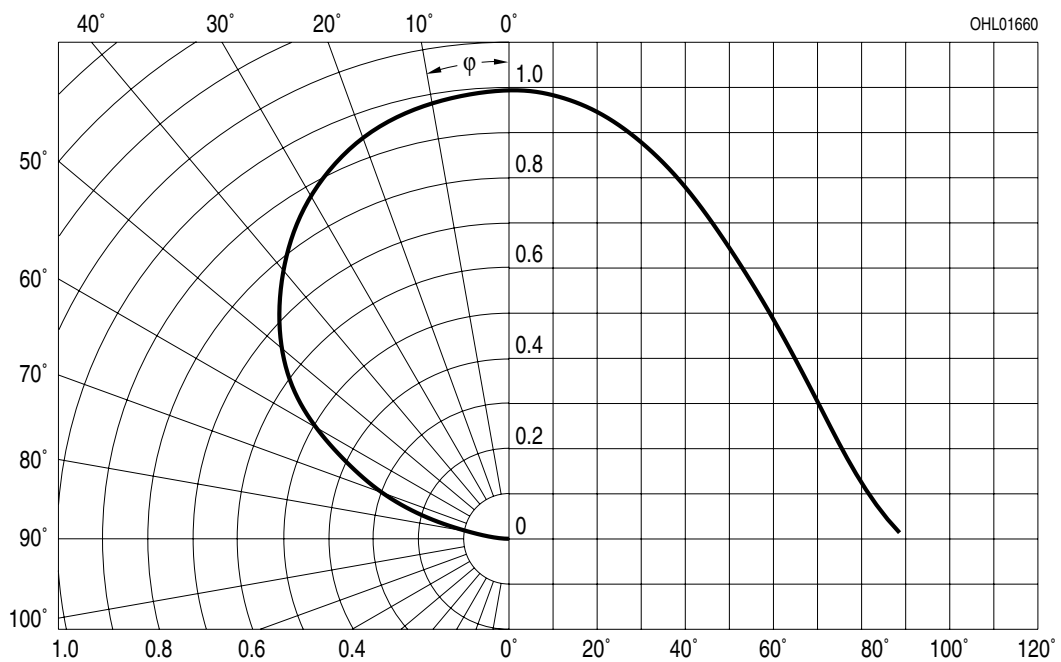
Relative Spectral Emission ⁶⁾

$I_{rel} = f(\lambda); I_F = 50 \text{ mA}; T_A = 25 \text{ }^\circ\text{C}$



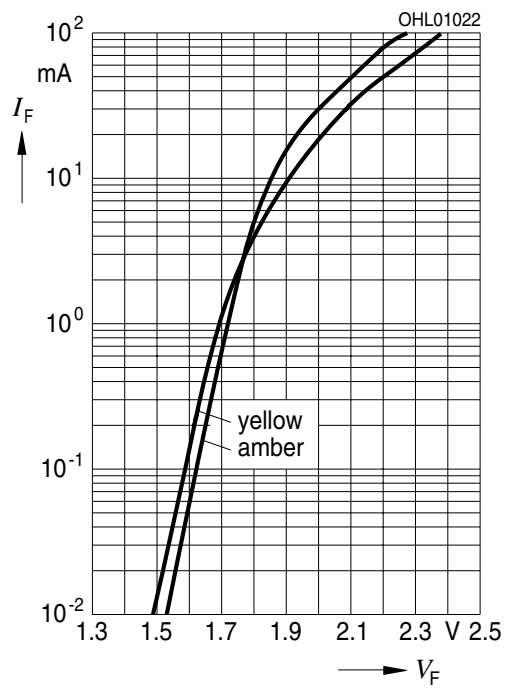
Radiation Characteristics ⁶⁾

$I_{rel} = f(\phi); T_A = 25 \text{ }^\circ\text{C}$



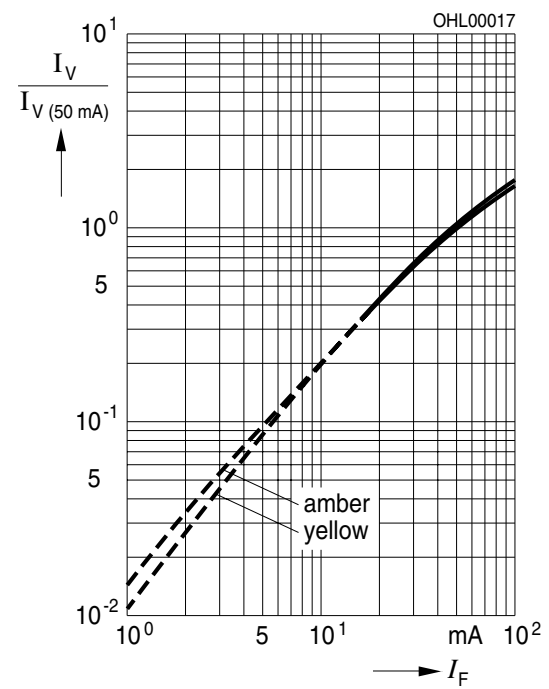
Forward current ^{6), 7)}

$I_F = f(V_F); T_A = 25\text{ °C}$



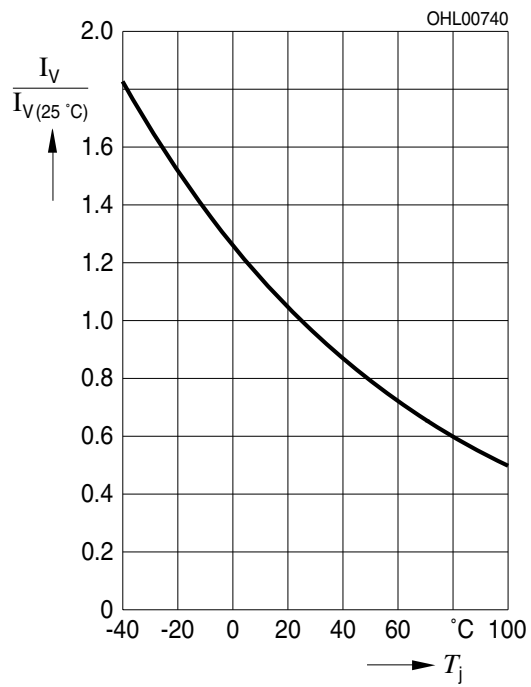
Relative Luminous Intensity ^{6), 7)}

$I_V/I_V(50\text{ mA}) = f(I_F); T_A = 25\text{ °C}$



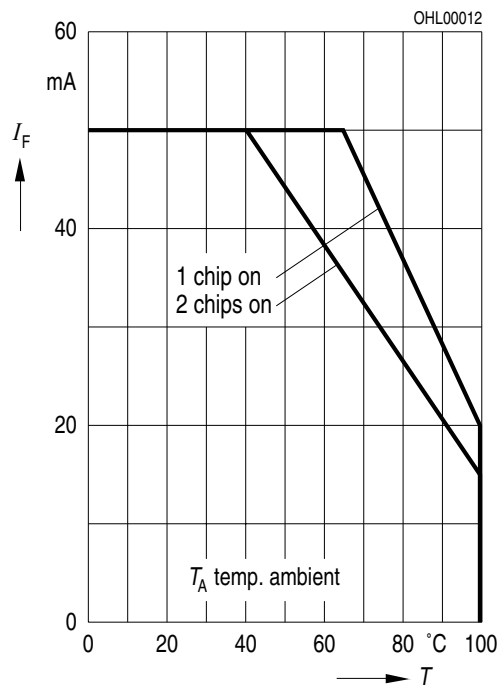
Relative Luminous Intensity ⁶⁾

$$I_V/I_{V(25\text{ }^\circ\text{C})} = f(T_j); I_F = 50\text{ mA}$$



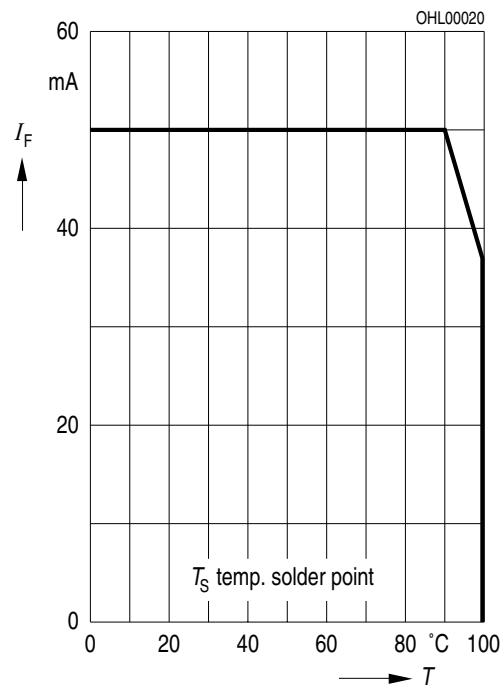
Max. Permissible Forward Current

$I_F = f(T)$; • amber



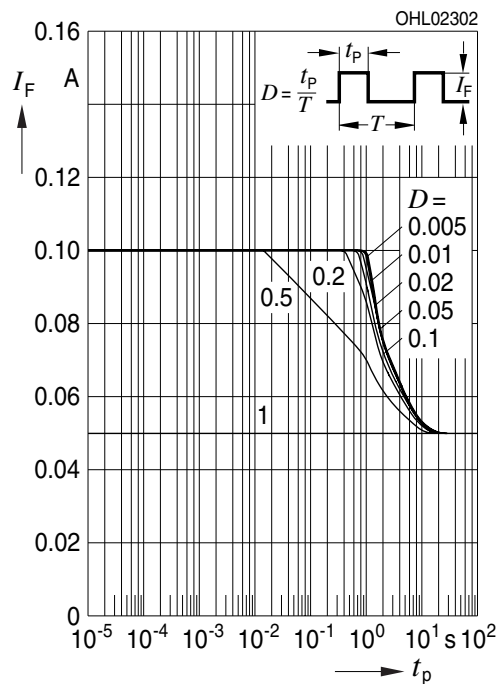
Max. Permissible Forward Current

$I_F = f(T)$; • amber



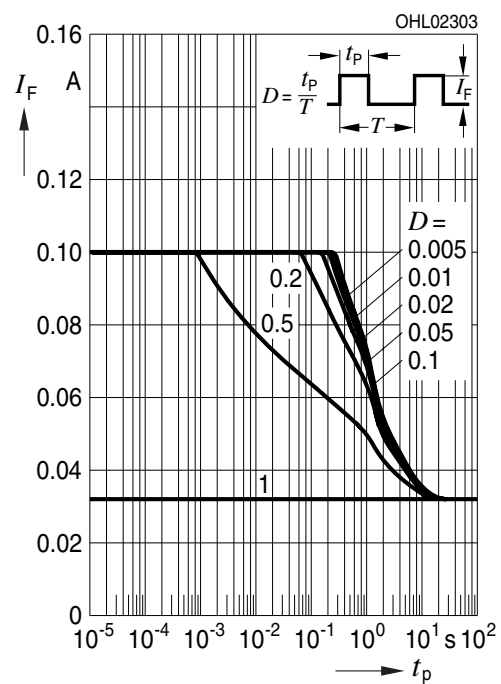
Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; $T_A = 25\text{ °C}$; • amber

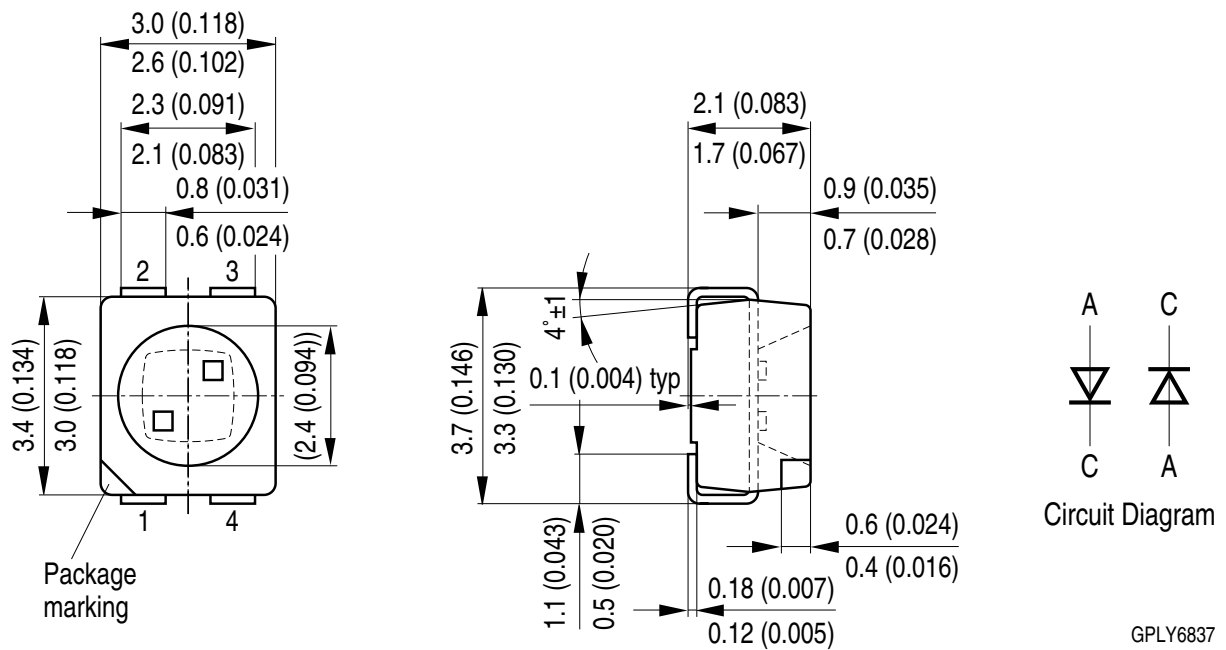


Permissible Pulse Handling Capability

$I_F = f(t_p)$; D: Duty cycle; $T_A = 85\text{ °C}$; • amber



Dimensional Drawing ⁸⁾



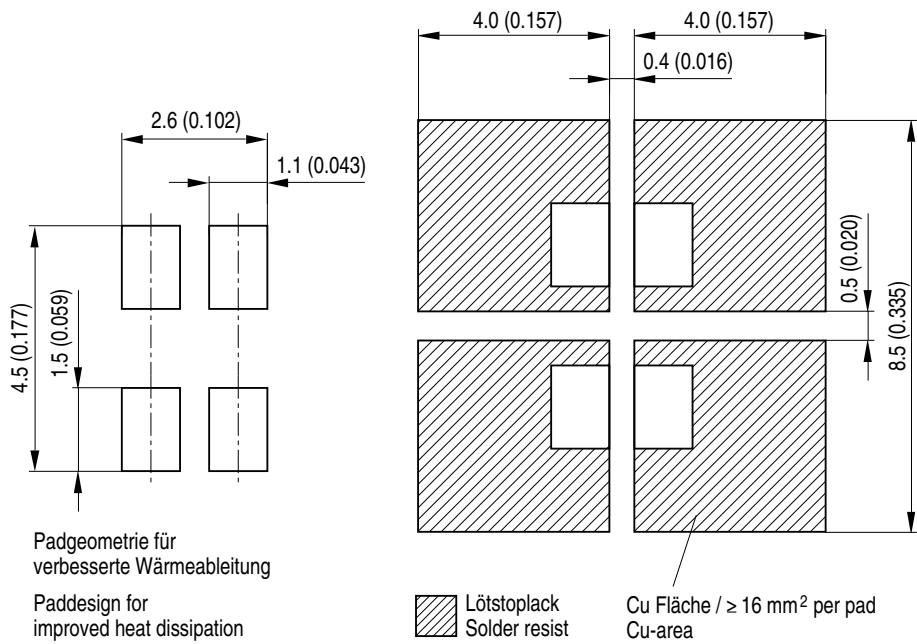
GPLY6837

Further Information:

Approximate Weight: 31.0 mg

Corrosion test: Class: 3B
 Test condition: 40°C / 90 % RH / 15 ppm H₂S / 14 days (stricter than IEC 60068-2-43)

Recommended Solder Pad ⁸⁾



OHLPY692

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

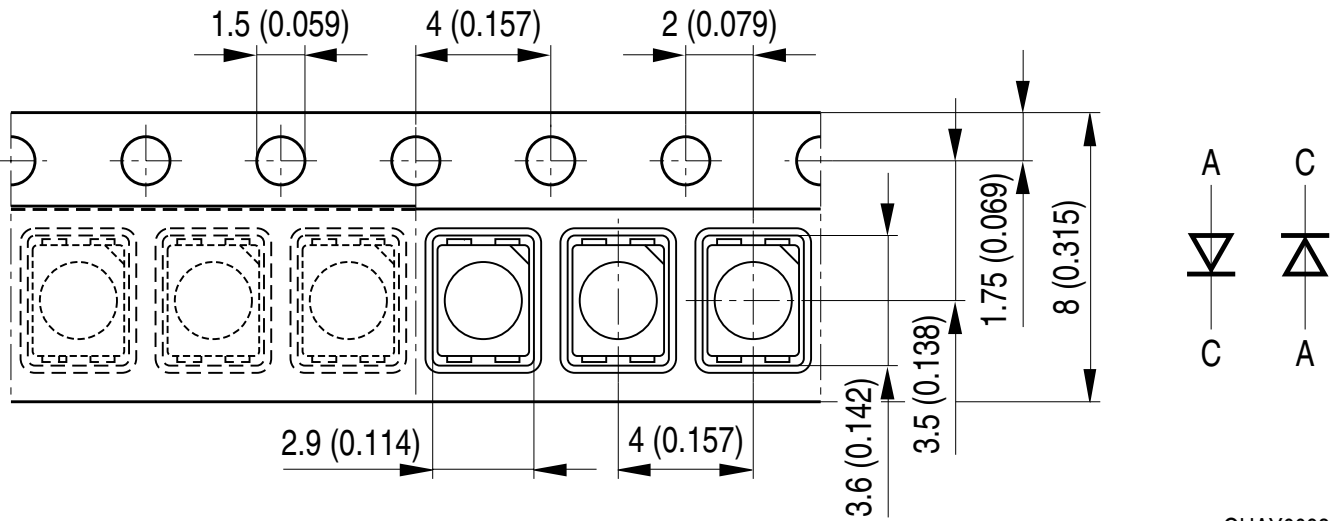


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat ^{*)} 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak ^{*)} T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	260	°C
Time within 5 °C of the specified peak temperature $T_p - 5$ K	t_p	10	20	30	s
Ramp-down rate* T_p to 100 °C			3	6	K/s
Time 25 °C to T_p				480	s

All temperatures refer to the center of the package, measured on the top of the component

* slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Taping ⁸⁾



OHAY0093

Tape and Reel ⁹⁾



Reel Dimensions

A	W	N_{min}	W_1	W_{2max}	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	2000
330 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	8000

Barcode-Product-Label (BPL)

OSRAM Opto Semiconductors LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant

(6P) BATCH NO: 1234567890 ML Temp ST
X XXX °C X

(1T) LOT NO: 1234567890 (9D) D/C: 1234

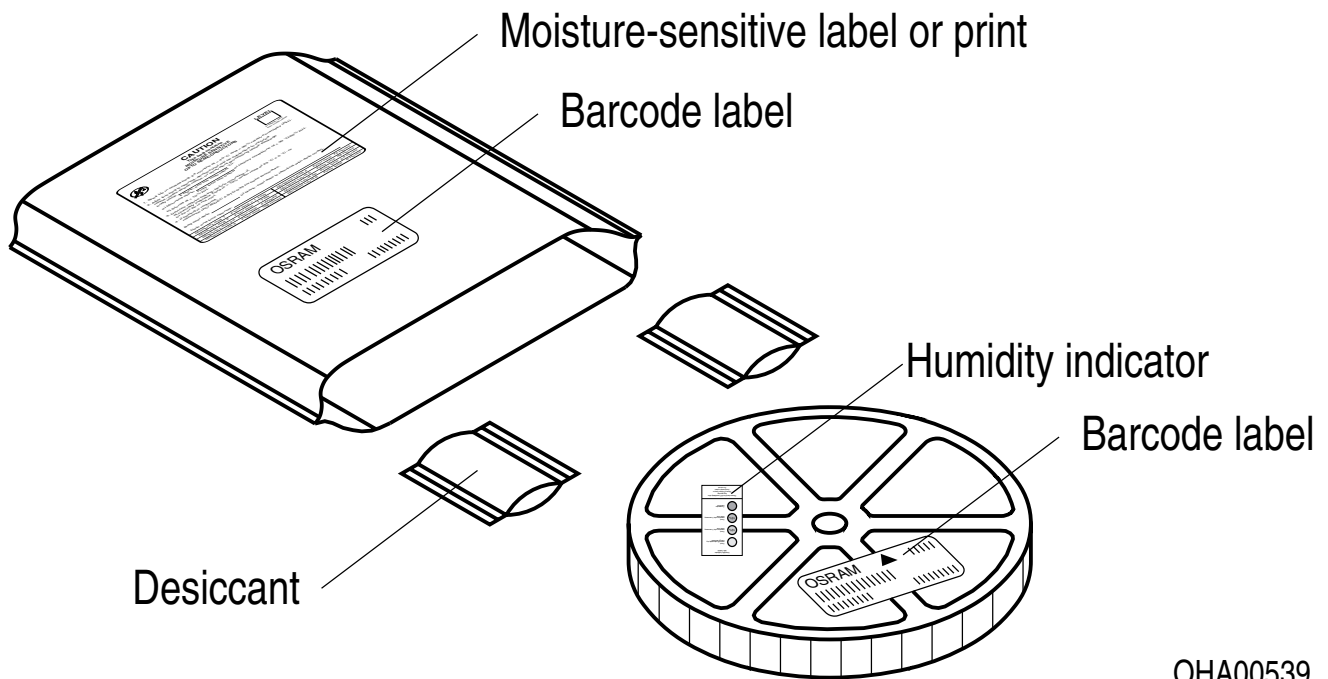
(X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X

Pack: RXX
DEMY XXX
X_X123_1234.1234 X



OHA04563

Dry Packing Process and Materials ⁸⁾



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

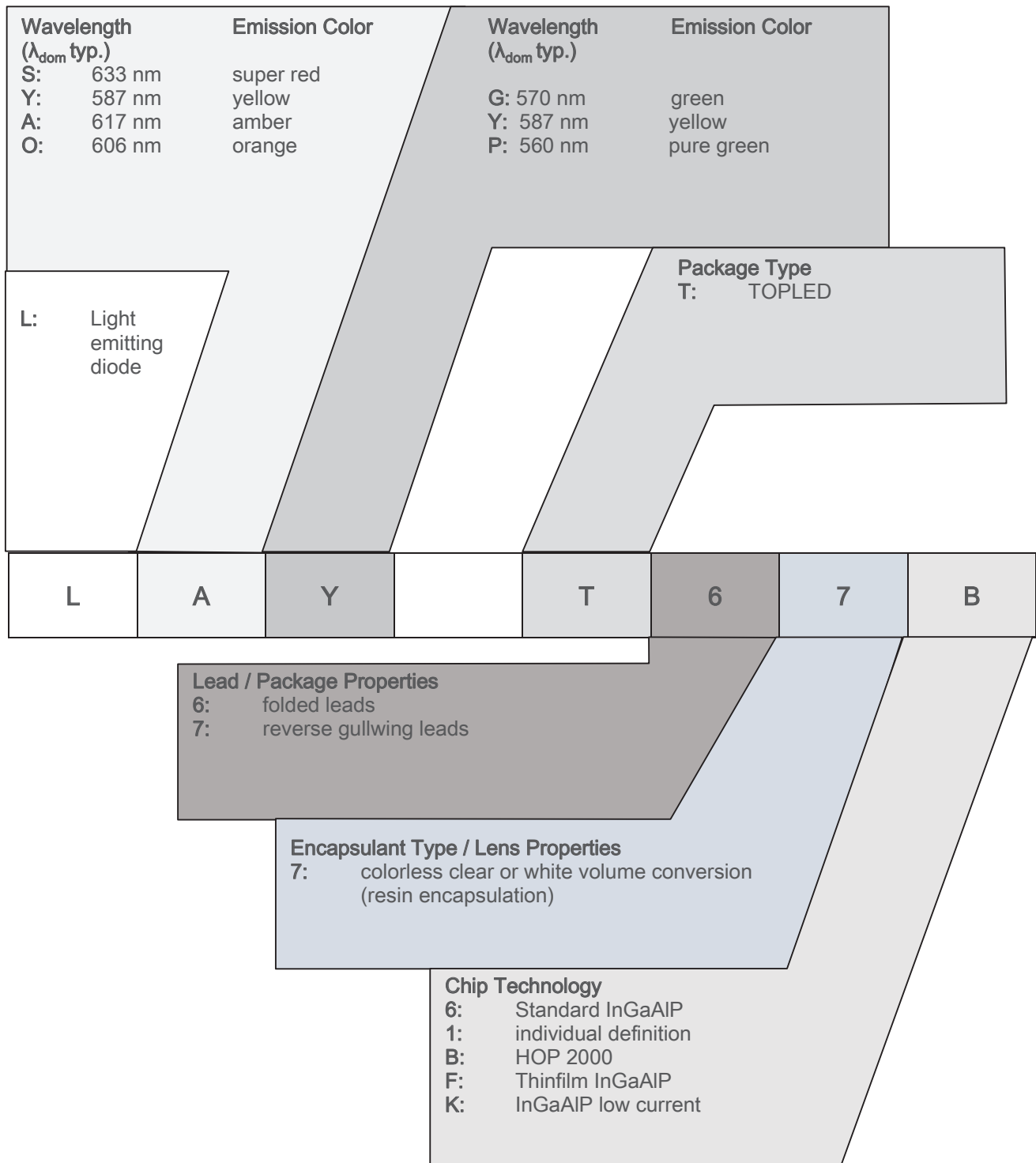
Schematic Transportation Box ⁸⁾



Dimensions of Transportation Box

Width	Length	Height
200 ± 5 mm	195 ± 5 mm	30 ± 5 mm
352 ± 5 mm	352 ± 5 mm	33 ± 5 mm

Type Designation System



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

Glossary

- 1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (acc. to GUM with a coverage factor of $k = 3$).
- 2) **Reverse Operation:** Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- 3) **Wavelength:** The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ± 0.5 nm and an expanded uncertainty of ± 1 nm (acc. to GUM with a coverage factor of $k = 3$).
- 4) **Forward Voltage:** Forward voltages are tested at a current pulse duration of 1 ms and a tolerance of ± 0.05 V and an expanded uncertainty of ± 0.1 V (acc. to GUM with a coverage factor of $k = 3$).
- 5) **Thermal Resistance:** $R_{th\ max}$ is based on statistic values (6σ).
- 6) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 7) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 8) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 9) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.0	2019-10-22	New Layout

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